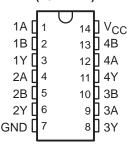
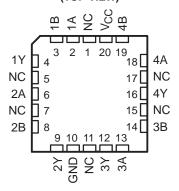
- Operating Voltage Range of 4.5 V to 5.5 V
- Outputs Can Drive Up To 10 LSTTL Loads
- Low Power Consumption, 20-μA Max I<sub>CC</sub>

SN54HCT08...J OR W PACKAGE SN74HCT08...D, DB, N, NS, OR PW PACKAGE (TOP VIEW)



- Typical t<sub>pd</sub> = 13 ns
- ±4-mA Output Drive at 5 V
- Low Input Current of 1 μA Max
- Inputs Are TTL-Voltage Compatible

SN54HCT08 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

### description/ordering information

These devices contain four independent 2-input AND gates. They perform the Boolean function  $Y = A \bullet B$  or  $Y = \overline{A} + \overline{B}$  in positive logic.

#### ORDERING INFORMATION

TA	PACKAGE <sup>†</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – N	Tube of 25	SN74HCT08N	SN74HCT08N
		Tube of 50	SN74HCT08D	
	SOIC - D	Reel of 2500	SN74HCT08DR	HCT08
		Reel of 250	SN74HCT08DT	
–40°C to 85°C	SOP – NS Reel of 2000		SN74HCT08NSR	HCT08
	SSOP - DB	Reel of 2000	SN74HCT08DBR	HT08
		Tube of 90	SN74HCT08PW	
	TSSOP – PW	Reel of 2000	SN74HCT08PWR	HT08
		Reel of 250	SN74HCT08PWT	
	CDIP – J	Tube of 25	SNJ54HCT08J	SNJ54HCT08J
–55°C to 125°C	CFP – W	Tube of 150	SNJ54HCT08W	SNJ54HCT08W
	LCCC – FK	Tube of 55	SNJ54HCT08FK	SNJ54HCT08FK

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



# FUNCTION TABLE (each gate)

INP	JTS	OUTPUT
Α	В	Υ
Н	Н	Н
L	Χ	L
Х	L	L

#### logic diagram (positive logic)



### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>		0.5	V to 7 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) (see	ee Note 1)		±20 mA
Output clamp current, IOK (VO < 0 or VO > VCO	c) (see Note 1)		±20 mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )			±25 mA
Continuous current through V <sub>CC</sub> or GND			±50 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 2):	D package		86°C/W
,	DB package		96°C/W
	N package		80°C/W
	NS package		76°C/W
	PW package		113°C/W
Storage temperature range, T <sub>stg</sub>		-65°C	to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

# recommended operating conditions (see Note 3)

			SI	SN54HCT08		SN74HCT08			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	\$ 5.5	4.5	5	5.5	V
VIH	High-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2	Š	,/	2			V
$V_{IL}$	Low-level input voltage	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		72/2	0.8			0.8	V
VI	Input voltage		0	1	VCC	0		VCC	V
٧o	Output voltage		0	2	VCC	0		VCC	V
Δt/Δν	Input transition rise/fall time		0~	)*	500			500	ns
TA	Operating free-air temperature		-55		125	-40		85	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>2.</sup> The package thermal impedance is calculated in accordance with JESD 51-7.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST COL	NDITIONS	Vaa	Т	A = 25°C	;	SN54F	ICT08	SN74H	ICT08	UNIT
PARAMETER	TEST COI	NDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
Vari	VI = VIH or VIL	I <sub>OH</sub> = -20 μA	4.5 V	4.4	4.499		4.4		4.4		V
VOH	AI = AIH OL AIL	$I_{OH} = -4 \text{ mA}$	4.5 V	3.98	4.3		3.7	7	3.84		٧
Voi	VI = VIH or VIL	I <sub>OL</sub> = 20 μA	4.5 V		0.001	0.1		0.1		0.1	V
VOL	AI = AIH OL AIL	I <sub>OL</sub> = 4 mA			0.17	0.26		0.4		0.33	ľ
lį	$V_I = V_{CC}$ or 0		5.5 V		±0.1	±100	`	±1000		±1000	nA
Icc	$V_I = V_{CC}$ or 0,	I <sub>O</sub> = 0	5.5 V			2	2/2	40		20	μΑ
ΔI <sub>CC</sub> †	One input at 0.5 V of Other inputs at 0 or		5.5 V		1.4	2.4	704 <sub>0</sub>	3		2.9	mA
Ci			4.5 V to 5.5 V		3	10		10		10	pF

This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than 0 V or VCC.

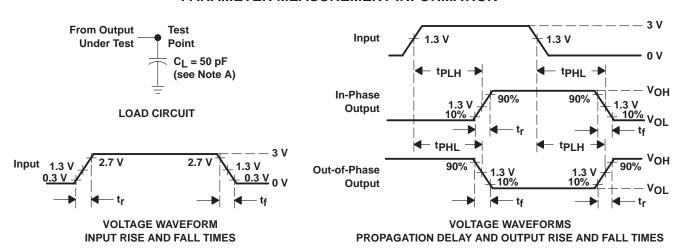
# switching characteristics over recommended operating free-air temperature range, $C_L$ = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	Vaa	T,	ղ = 25°C	;	SN54HCT08	SN74H	CT08	LIMIT
PARAMETER	(INPUT)	(OUTPUT)	VCC	MIN	TYP	MAX	MIN MAX	MIN	MAX	UNIT
4 .	A or B	Y	4.5 V		15	24	35		30	no
<sup>t</sup> pd			5.5 V		13	22	32		27	115
t <sub>t</sub> Y	V	4.5 V		9	15	P 22		19		
		ſ	5.5 V		8	14	20		17	ns ns

# operating characteristics, T<sub>A</sub> = 25°C

	PARAMETER	TEST CONDITIONS	TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance per gate	No load	20	pF

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A.  $C_L$  includes probe and test-fixture capacitance.

- B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50 \Omega$ ,  $t_r = 6$  ns,  $t_f = 6$  ns.
- C. The outputs are measured one at a time with one input transition per measurement.
- D. tplH and tpHL are the same as tpd.

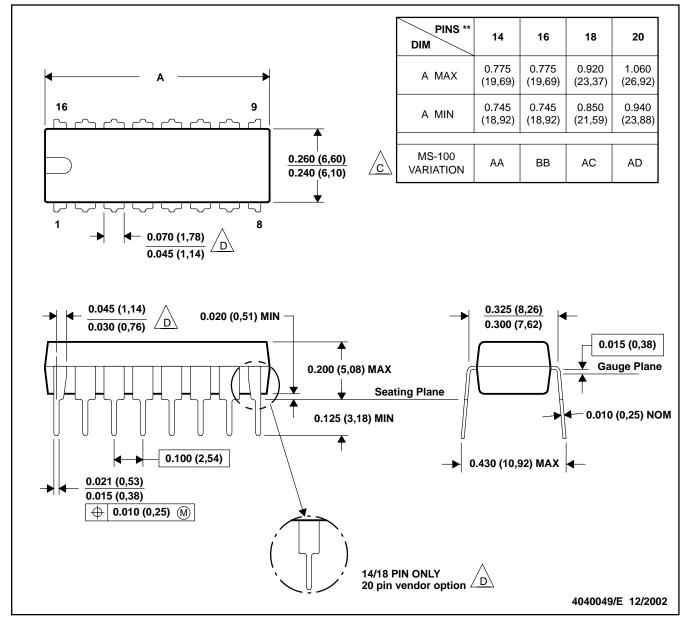
Figure 1. Load Circuit and Voltage Waveforms



#### N (R-PDIP-T\*\*)

#### **16 PINS SHOWN**

#### PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

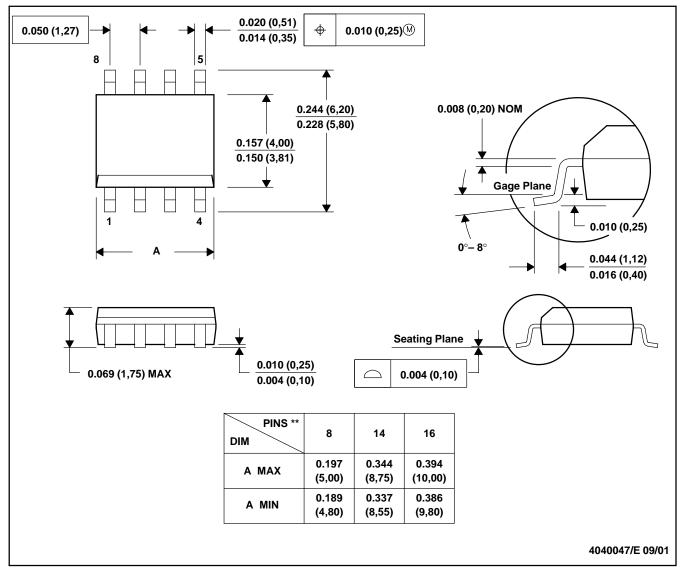
Falls within JEDEC MS-001, except 18 and 20 pin minimum body Irngth (Dim A).

The 20 pin end lead shoulder width is a vendor option, either half or full width.

#### D (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE PACKAGE

#### **8 PINS SHOWN**



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012

# **MECHANICAL DATA**

# NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

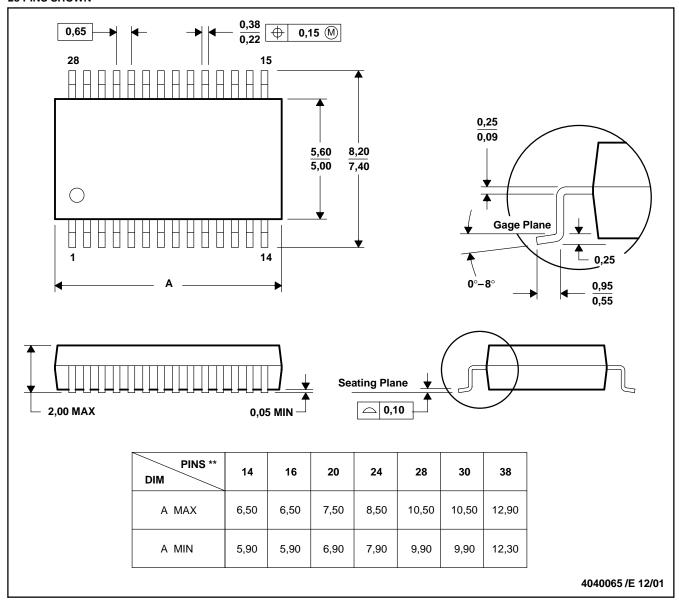
- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



# DB (R-PDSO-G\*\*)

# PLASTIC SMALL-OUTLINE

#### **28 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

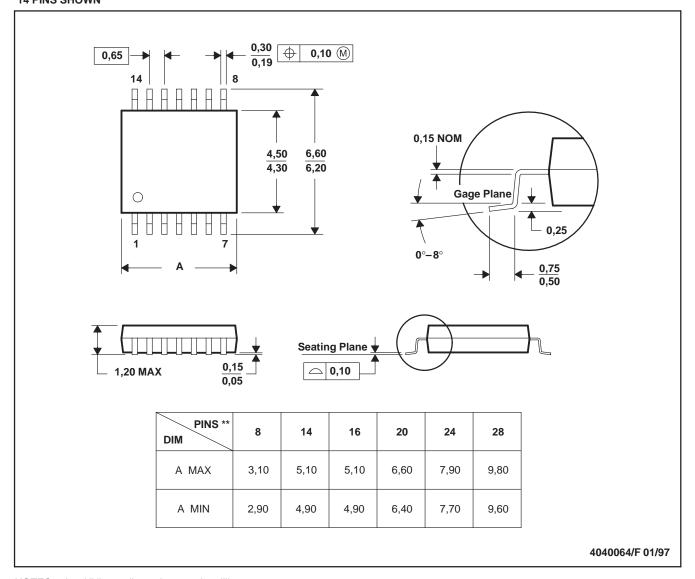
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

# PW (R-PDSO-G\*\*)

#### 14 PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

#### **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

Copyright © 2003, Texas Instruments Incorporated